				Commerce Patent and Trademark	
11-7-03	10260217	74			
To the Commissioner for Patent	s. Please record the attached origin	nal documents or copie	s thereof.		
1. Name of Conveying Party(ies):		2. Name and Address	of Receiving F	Party(ies):	
Chiou-	Tsu KIN Mei CHEN	Name:	Industrial Institute	Technology Resear	
Jen-Chung LOU Ching-Yi HSU Farhang SHADMAN		Street Address:	195, Sec. 4, Chung Hsing Road Chutung		
3. Nature of Conveyance:					
⊠Assignment □ Security Agreeme □ Other:	□ Merger ent □ Change of Name	City, State, Zip:	Hsinchu,	Taiwan, 310	
Execution Date	11/03/03; 11/03/03; 11/03/03; 11/03/03; 10/28/03	D Additional n	ame(s) and	address(es) attached	
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f this document is being filed toget application, the execution date of th	ne application is: 10/28/03				
5 Name and Address of Party to w	Additional Num hom Correspondence Concerning this	bers Attached. Total Number of App	lications and	·	
Document Should be Mailed:	ion conception of concerning this		nts Involved:	1	
Name:	Eugene Mar	7. Total Fee: (37 CFR 3.41)		\$40.00	
23364	Bacon & Thomas, PLLC 625 Slaters Lane Fourth Floor Alexandria, VA 22314	☑ Enclosed □ Authorized to be cl	be charged to deposit account		
CUSTOMER NUMBER	}	8. Deposit Account Nu	ımber:	02-0200	
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9. Statement and Signature:					
-	wledge and belief, the foregoing nal document.	is true and correct a	nd any attac	ched copy is a	

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Patent Application Docket #: <u>kink3334</u>CM

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN AND TRANSFER to Industrial Technology Research Institute (the "Assignee"), whose post office address is 195 Section 4, Chung Hsing Road, Chutung, Hsinchu, Taiwan 310, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned on $\underline{loct}, \underline{28}, \underline{loc}, \underline{3}, \underline{200}$, and is entitled "METHOD AND APPARATUS FOR TREATING A SUBSTRATE SURFACE BY BUBBLING " such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, that when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Kon- Jon Kin

Kon-Tsu Kin

Address:

<u>Nov. 3, 200)</u> Date

195 Section 4, Chung Hsing Road, Chutung, Hsinchu, Taiwan 310

PATENT REEL: 014689 FRAME: 0075

Chion-Nei Chin Chiou-Mei Chen

<u>_//-3-2∞3</u> Date

Chiou-Iviel Che

Address:

195 Section 4, Chung Hsing Road, Chutung, Hsinchu, Taiwan 310

Jer Chung Lou

<u> Vdv. 3. 2003</u> Date

Address:

Department of Electronics, National Chiao Tung University, Hsinchu, Taiwan

ching - Fi HSU China-Yi Hsu

/1- ->003 Date

Address:

195 Section 4, Chung Hsing Road, Chutung, Hsinchu, Taiwan 310

adn

<u>10-28-03</u> Date

Faihang Shadman

Address:

Department of Chemical and Environmental Engineering, University of Arizona Tucson, Arizona 85721-0012 USA

-- End --

RECORDED: 11/07/2003